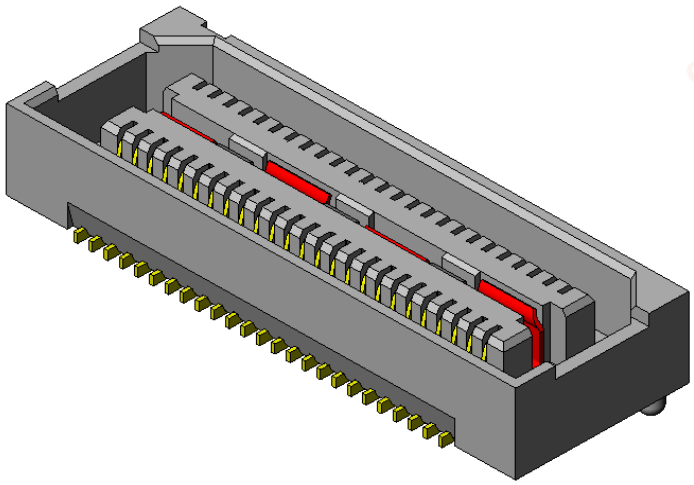
chanhvinh.com

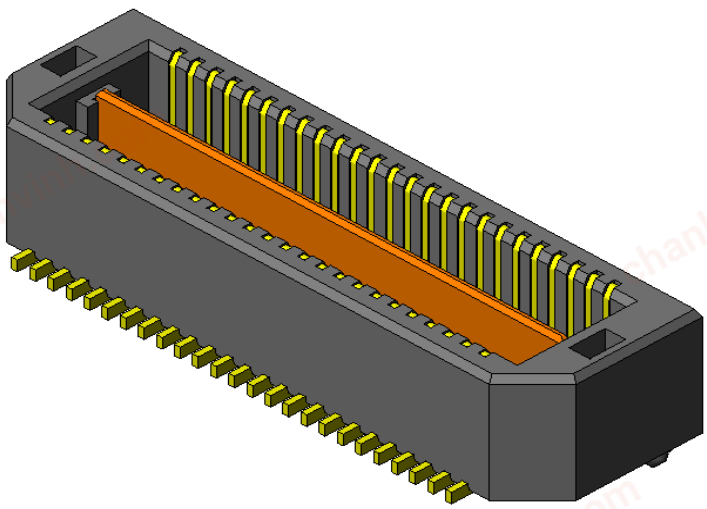
Product Specification

Series: QSS / QTS 0,635mm High Speed Socket / Terminal Strips

QSS Series – Socket, Vertical Orientation



QTS Series – Terminal, Vertical Orientation



Other configurations available for:

- Co-planar and perpendicular board-to-board applications
- Rugged features / end options
- Packaging options

See www.samtec.com for more information.

© 2012 Samtec, Inc.

chanhvinh.com

Series: QSS / QTS 0,635mm High Speed Socket / Terminal Strips

1.0 SCOPE

1.1 This specification covers performance, testing and quality requirements for Samtec QSS/QTS Series 0,635 mm High Speed Socket/Terminal Strips. These socket and terminal strips are available in vertical, edge mount and right angle configurations for parallel, perpendicular and co-planar board-to-board applications. All information contained in this specification is for a 5,00 mm mated height vertical configuration unless otherwise noted.

2.0 DETAILED INFORMATION

2.1 Product prints, footprints, catalog pages, test reports and other specific, detailed information can be found at www.samtec.com?QSS and www.samtec.com?QTS.

3.0 TESTING

3.1 Current Rating: 1.3A
3.2 Voltage Rating: 275 VAC
3.3 Operating Temperature Range: -55°C to +125°C
3.4 Electrical:

ITEM	TEST CONDITION	REQUIREMENT	STATUS
Withstanding Voltage	EIA-364-20 (No Flashover, Sparkover, or Breakdown)	825 VAC	Pass
Insulation Resistance	EIA-364-21 (5000 MΩ minimum)	15,000 MΩ	Pass
Contact Resistance (LLCR)	EIA-364-23	Δ 15 mΩ maximum (Samtec defined)/ No damage	Pass

3.5 Mechanical:

ITEM	TEST CONDITION	REQUIREMENT	STATUS
Durability	EIA-364-09C	100 cycles (10µ" Au), 500 cycles (30µ" Au)	Pass
Random Vibration	EIA-364-28 Condition V, Letter B 7.56 G 'RMS', 50 to 2000 Hz, 2 hours per axis, 3 axis total , PSD 0.04	Visual Inspection: No Damage LLCR: Δ 15 mΩ maximum Event Detection: No interruption > 1.0 microsecond	Pass
Mechanical Shock	EIA-364-27 100 G, 6 milliseconds, sawtooth wave, 11.3 fps, 3 shocks/direction, 3 axis (18 total shocks)	Visual Inspection: No Damage LLCR: Δ 15 mΩ maximum Event Detection: No interruption > 1.0 microsecond	Pass
Normal Force	EIA-364-04	30 grams minimum for gold interface	Pass

© 2012 Samtec, Inc.

chanhvinh.com

Series: QSS / QTS 0,635mm High Speed Socket / Terminal Strips

3.6 Environmental:

ITEM	TEST CONDITION	REQUIREMENT	STATUS
Thermal Shock	EIA-364-32 Thermal Cycles: 100 (30 minute dwell) Hot Temp: 85°C Cold Temp: -55°C Hot/Cold Transition: Immediate	Visual Inspection: No Damage LLCR: Δ 15 mΩ DWV: 825 VAC IR: >15,000 MΩ	Pass
Thermal Aging (Temp Life)	EIA-364-17 Test Condition 4 @ 105°C Condition B for 250 hours	Visual Inspection: No Damage LLCR: Δ 15 mΩ DWV: 825 VAC IR: >15,000 MΩ	Pass
Cyclic Humidity	EIA-364-31 Test Temp: 25°C to 65°C Relative Humidity: 90 to 95% Test Duration: 240 hours	Visual Inspection: No Damage LLCR: Δ 15 mΩ DWV: 825 VAC IR: >15,000 MΩ	Pass
Gas Tight	EIA-364-36 Gas Exposure: Nitric Acid Vapor Duration: 60 min. Drying Temp.: 50°C +/- 3°C Measurements: Within 1 hour of Exposure	LLCR: Δ 15 mΩ	Pass

© 2012 Samtec, Inc.

chanhvinh.com

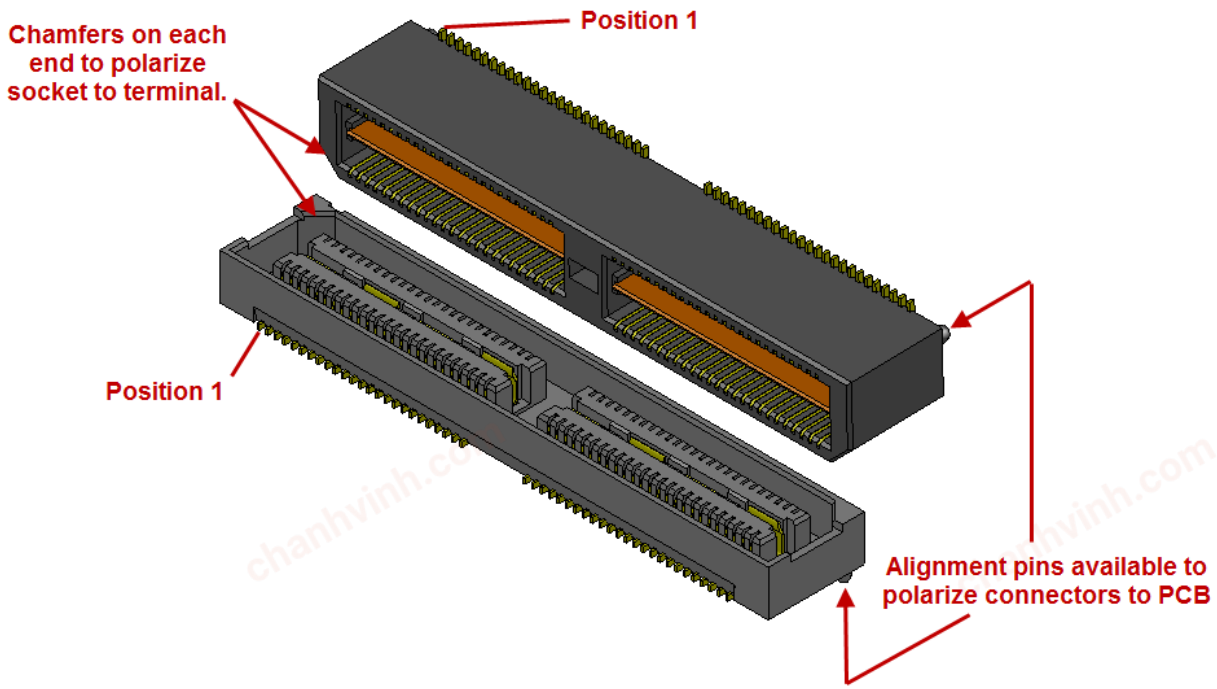
Series: QSS / QTS 0,635mm High Speed Socket / Terminal Strips

4.0 MATED SYSTEM

4.1 Mated Views:

Mated view information can be found at link below:
https://suddendocs.samtec.com/prints/qss - qts mated document-mkt.pdf

5.0 POLARIZING FEATURES



6.0 HIGH SPEED PERFORMANCE

6.1 Based on a 3 dB insertion loss
6.2 System Impedance: 50 ohm for single-ended and 100 ohm for differential pair

Stack Height	Single-Ended Signaling	Differential Pair Signaling
5mm	9.00 GHz	8.50 GHz
11mm	6.00 GHz	5.50 GHz
16mm	5.00 GHz	5.00 Ghz

© 2012 Samtec, Inc.

chanhvinh.com

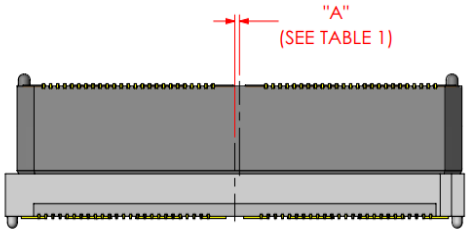
Series: QSS / QTS 0,635mm High Speed Socket / Terminal Strips

7.0 PROCESSING RECOMMENDATIONS

7.1 Mating Alignment Requirements:

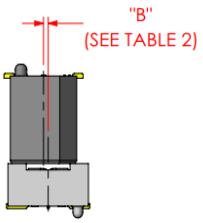
7.1.1 Allowable initial linear misalignment

TABLE 1		
ORIENTATION	OPTION	"A"
DV TO DV	STANDARD	.017 [0.43]
	-GP OPTION	.034 [0.86]
RA TO RA	STANDARD	.030 [0.76]



INITIAL X AXIS LINEAR MISALIGNMENT

TABLE 2		
ORIENTATION	OPTION	"B"
DV TO DV	STANDARD	.017 [0.43]
	-GP OPTION	.032 [0.81]
RA TO RA	STANDARD	.040 [1.02]



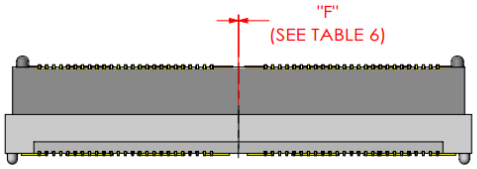
INITIAL Y AXIS LINEAR MISALIGNMENT

NON APPLICABLE

INITIAL Z AXIS LINEAR MISALIGNMENT

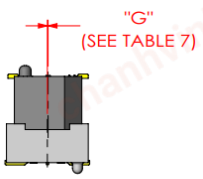
7.1.2 Allowable final linear misalignment

TABLE 6	
ORIENTATION	"F"
DV TO DV	.001 [0.03]
RA TO RA	.001 [0.03]



FINAL X AXIS LINEAR MISALIGNMENT

TABLE 7	
ORIENTATION	"G"
DV TO DV	.0020 [0.05]
RA TO RA	.0025 [0.06]



FINAL Y AXIS LINEAR MISALIGNMENT

SEE MATED VIEW

FINAL Z AXIS LINEAR MISALIGNMENT

© 2012 Samtec, Inc.

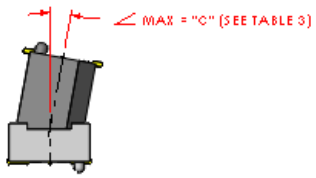
chanhvinh.com

Series: QSS / QTS 0,635mm High Speed Socket / Terminal Strips

7.2 Mating Angle Requirements:

7.2.1 Allowable initial angular misalignment

TABLE 3	
ORIENTATION	"C" = DEG
DV TO DV	10.5
RA TO RA	3.1



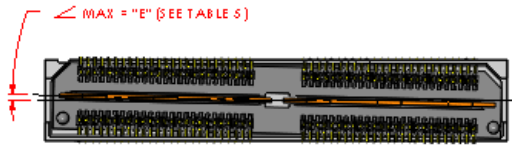
INITIAL X AXIS ANGULAR MISALIGNMENT

TABLE 4		
POS	"D" = DEG (DV TO DV)	"D" = DEG (RA TO RA)
-025	5.1	5.8
-050	2.5	2.9
-075	1.7	1.9
-100	1.3	1.4
-125	1.0	N/A



INITIAL Y AXIS ANGULAR MISALIGNMENT

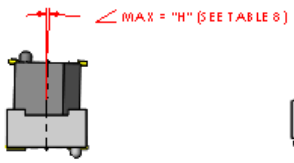
TABLE 5		
POS	"E" = DEG (DV TO DV)	"E" = DEG (RA TO RA)
-025	2.2	2.9
-050	1.1	1.5
-075	0.7	1.0
-100	0.5	0.7
-125	0.4	N/A



INITIAL Z AXIS ANGULAR MISALIGNMENT

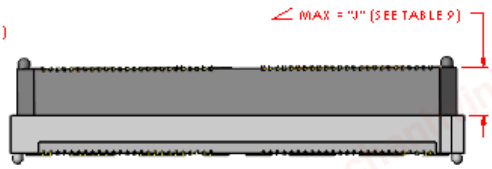
7.2.2 Allowable final angular misalignment

TABLE 8	
ORIENTATION	"H" = DEG
DV TO DV	1.3
RA TO RA	2.0



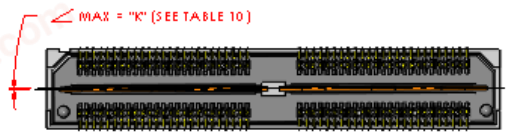
FINAL X AXIS ANGULAR MISALIGNMENT

TABLE 9			
POS	"J" = DEG (DV TO DV)	"J" = DEG (DV TO DV WITH - GP OPTION)	"J" = DEG (RA TO RA)
-025	0.52	0	0.72
-050	0.26	0	0.36
-075	0.17	0	0.24
-100	0.13	0	0.18
-125	0.10	0	N/A



FINAL Y AXIS ANGULAR MISALIGNMENT

TABLE 10		
POS	"K" = DEG (DV TO DV)	"K" = DEG (RA TO RA)
-025	0.43	1.5
-050	0.21	0.73
-075	0.14	0.49
-100	0.11	0.37
-125	0.09	N/A



FINAL Z AXIS ANGULAR MISALIGNMENT

7.3 Multiple Connector Applications: Not recommended for applications in which multiple connectors are mated to a single daughtercard. For more information, please contact IPG@samtec.com.

© 2012 Samtec, Inc.

chanhvinh.com

7.4 Due to variances in equipment, solder pastes and applications (board design, component density, etc.), Samtec does not specify a recommended reflow profile for our connectors. The processing parameters provided by the solder paste manufacturer should be employed and can usually be found on their website.

All of Samtec's surface mount components are lead free reflow compatible and compliant with the profile parameters detailed in IPC/JEDEC J-STD-020 which requires that components be capable of withstanding a peak temperature of 260°C as well as 30 seconds above 255°C.

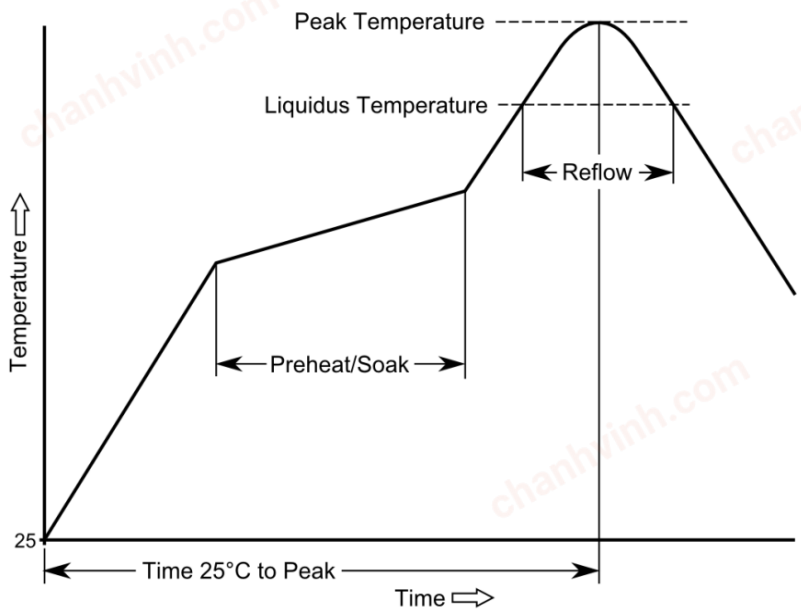
Samtec Recommended Temperature Profile Ranges (SMT)

Sn-Pb Eutectic Assembly

Preheat/Soak (100°C-150°C)	Max Ramp Up Rate	Reflow Time (above 183°C)	Peak Temp	Time within 5°C of 235°C	Max Ramp Down Rate	Time 25°C to Peak Temp
60-120 sec.	3°C/s max.	40-150 sec.	235°C	20 sec. max.	6°C/s max.	6 min. max.

Pb-Free Assembly

Preheat/Soak (150°C-200°C)	Max Ramp Up Rate	Reflow Time (above 217°C)	Peak Temp	Time within 5°C of 260°C	Max Ramp Down Rate	Time 25°C to Peak Temp
60-120 sec.	3°C/s max.	40-150 sec.	260°C	30 sec. max.	6°C/s max.	8 min. max.



7.4.1

These guidelines should not be considered design requirements for all applications.
Samtec recommends testing interconnects on your boards in your process to guarantee optimum results.

© 2012 Samtec, Inc.

chanhvinh.com

Series: QSS / QTS 0,635mm High Speed Socket / Terminal Strips

7.5 Maximum Reflow Passes: The parts can withstand 3 reflow passes at a maximum component temperature of 260°C.

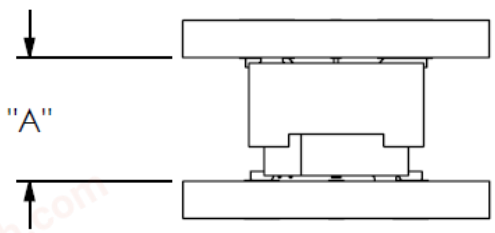
7.6 Stencil Thickness: The recommended stencil thickness is .006" (.15mm).

7.7 Placement: Machine placement of the parts is recommended.

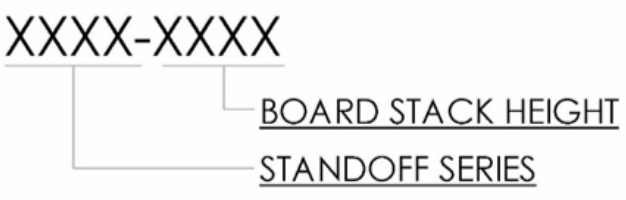
7.8 Reflow Environment: Samtec recommends the use of a low level oxygen environment (typically achieved through Nitrogen gas infusion) in the reflow process to improve solderability.

7.9 Rework Guidelines: Samtec recommends following these rework guidelines as needed: QXX/BXX Connector Rework Methods

7.10 Hardware: Board-to-board standoffs are recommended to provide a robust mechanical connection. Samtec offers several different types, which can be found here: Samtec Standoff Offerings.



	QSS LEAD STYLE	
	-01	
QTS LEAD STYLE	Nominal Connector Stack Height "A" in [mm]	Standoff
-01	.197 [5.00]	XXXX-0515
-02	.315 [8.00]	XXXX-0815
-03	.433 [11.00]	XXXX-1115
-04	.630 [16.00]	XXXX-1615
-05	.748 [19.00]	XXXX-1915
-06	.866 [22.00]	XXXX-2015



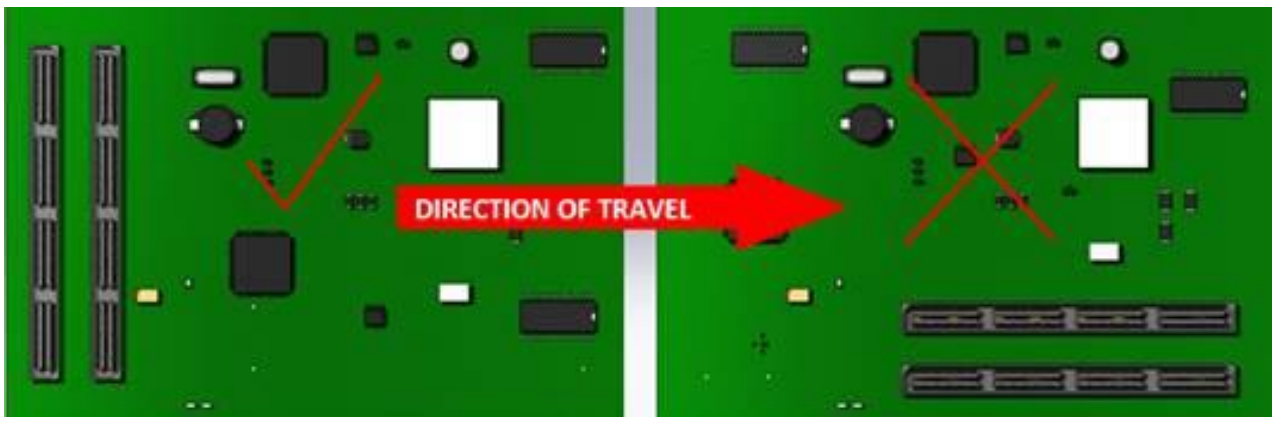
© 2012 Samtec, Inc.

chanhvinh.com

7.11 Cleaning: Samtec, Inc. has verified that our connectors may be cleaned in accordance with the solvents and conditions designated in the EIA-364-11 standard.

8.0 DIRECTION OF BOARD TRAVEL THROUGH REFLOW OVEN

8.1 To minimize the potential for connector warpage, Samtec recommends the layout configuration shown below left. This allows the connectors to heat more evenly.



9.0 ADDITIONAL RESOURCES

9.1 For additional mechanical testing or product information, contact our Customer Engineering Support Group at **CES@samtec.com**

9.2 For additional information on high speed performance testing, contact our Signal Integrity Group at **SIG@samtec.com**

9.3 For additional processing information, contact our Interconnect Processing Group at **IPG@samtec.com.**

9.4 For RoHS, REACH or other environmental compliance information, contact our Product Environmental Compliance Group at **PEC@samtec.com**

USE OF PRODUCT SPECIFICATION SHEET

This Product Specification Sheet ("PSS") is a brief summary of information related to the Product identified. As a summary, it should only be used for the limited purpose of considering the purchase/use of Product. For specific, detailed information, including but not limited to testing and Product footprint, refer to Section 2.0 of this document and the links there provided to test reports and prints. This PSS is the property of Samtec, Inc. ("Samtec") and contains proprietary information of Samtec, our various licensors, or both. Samtec does not grant express or implied rights or license under any patent, copyright, trademark or other proprietary rights and the use of the PSS for building, reverse engineering or replication is strictly prohibited. By using the PSS, the user agrees to not infringe, directly or indirectly, upon any intellectual property rights of Samtec and acknowledges that Samtec, our various licensors, or both own all intellectual property therein. The PSS is presented "AS IS". While Samtec makes every effort to present excellent information, the PSS is only provided as a guideline and does not, therefore, warrant it is without error or defect or that the PSS contains all necessary and/or relevant information about the Product. The user agrees that all access and use of the PSS is at its own risk. **NO WARRANTIES EXPRESSED OR IMPLIED, INCLUDING ANY WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR OF ANY KIND WHATSOEVER ARE PROVIDED.**

© 2012 Samtec, Inc.